

TFT LCD Display Specification PN: GLT035320240IS1

Overview:

- 3.5" Diagonal
- IPS, Full View Angle
- Driver: ST7272A
- 16.7M Colors
- 1000 Nits

- 320 x 240 Pixels
- Transmissive/Normally Black
- RGB-24bit Interface
- No Touch Panel
- RoHS Compliant

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1. Record of Revision

Rev	Issued Date	Description	Editor
1.0	11/16/2020	First Release	ZWF
2.0	7/15/2021	Update the PIN interface definition	ZWF

2. General Specifications

I	eature	Spec
	Size	3.5 inch
	Resolution	320(horizontal) x 240(Vertical)
	Interface	RGB-24bit
	Connect type	Connector
Characteristics	Display Colors	16.7M
Characteristics	Pixel pitch (mm)	0.219 x 0.219
	Pixel Configuration	RGB Stripe
	Display Mode	Normally black
	LCD Driver IC	ST7272A
	Viewing Direction	Full view
	LCM (W x H x D) (mm)	76.90 x 63.90 x 4.89
	Active Area(mm)	70.08 x 52.56
Mechanical	With or without TSP	No
	Weight (g)	~30g
	LED Numbers	9 LEDS

Note 1: Requirements on Environmental Protection: RoHs

Note 2: LCM weight tolerance: +/- 5%

3. Input / Output Terminals

No.	Symbol	Description						
1-2	VBL-	Backlight LED Cathode						
3-4	VBL+	Backlight LED Anode.						
5	Y1(NC)	Touch panel up side (NC)						
6	X1(NC)	Touch panel right side (NC)						
7	NC	-						
8	RESET	Reset Signal pin ("Low" is enable)						
9	SPENB	Chip select						
10	SPCK	Serial Clock.						
11	SPDA	Serial Data						
12-19	B0~B7	Data bus						
20-27	G0~G7	Data bus						
28-35	R0~R7	Data bus						
36	HSYNC	Line Synchronous Signal						
37	VSYNC	Frame Synchronous Signal						
38	DOTCLK	Dot-clock signal and oscillator source						
39-40	NC	-						
41-42	VDD	Power supply for logic operation						
43	Y2(NC)	Touch panel bottom side (NC)						
44	X2(NC)	Touch panel left side (NC)						
45-47	NC	-						
48	IF2 (NC)	Control the input data format (NC)						
49	IF1 (NC)	Control the input data format (NC)						
50	IF0 (NC)	Control the input data format (NC)						
51	NC	-						
52	DEN	Display enable signal						
53-54	GND	System Ground						

4. Absolute Maximum Rating

Item	Symbol	MIN	Тур	MAX	Unit	Remark
Supply Voltage	Vdd	-0.5	-	5.0	V	-
Operating Temperature	Topr	-20	-	70	°C	-
Storage Temperature	Tstg	-30	-	80	°C	

5. Timing characteristics

5.1 Electrical Characteristics

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Supply Vo	oltago	Vcc	3.0	3.3	3.6	V	
Supply vo	Jilaye	IOVCC	1.65	3.0	3.3		
Input Signal	Low Leve	VIL	GND	-	0.1x VDD	V	
Voltage	High Level	Vін	0.8x VDD	-	VDD	V	
Output Signal	Low Leve	Vol	0	-	0.2*VDD	V	
Voltage	High Level	Vон	0.8*VDD	-	VDD	V	

5.2 LED Driving Conditions

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	lF	-	60	-	mA	
Forward Voltage	VF	9.0	9.6	10.2	V	
Backlight Power consumption	W _{BL}	-	0.576	-	W	
LED Lifetime		25,000	50,000	-	Hrs	

Note 1: Each LED: IF =20 mA, VF =3.2+/-0.2V.

Note 2: Optical performance should be evaluated at Ta=25°C only.

Note 3: If LED is driven by high current, high ambient temperature & humidity condition. The life Time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



Figure: LED connection of backlight (Constant Current)

5.3 Block Diagram



6. Interface Timing

6.1 AC Electrical Characteristics

Parameter Symbol Min. Max. Unit Conditions Typ. System Operation Timing VDD power source slew TPOR 1000 us From 0V to 90% VDD time RSTB active pulse width TRSTB 40 us VDD = 3.3V Input Output Timing Tclk 33.3/125 CLKIN clock time ns Please refer to timing table(p.32) . HSD to CLKIN Thc CLKIN --1 HSD width Thwh 1 CLKIN --VSD width Tvwh 1 Th --HSD period time Th 60 63.56 67 us VSD setup time Tvst 8 -ns VSD hold time Tvhd 10 -. ns HSD setup time Thst 8 -. ns HSD hold time Thhd 10 ns -Data set-up time Tdsu 8 -DIN[23:0] to CLKIN . ns Data hold time Tdhd 10 DIN[23:0] to CLKIN ns --DEN setup time 12 DEN to CLKIN Tesd ns @CCIR601 / 8bit RGB HV mode Time that VSD to 1st line Tvs 2 127 Th Control by HDLY[6:0] setting 13 data input Tvs = HDLY[6:0] @CCIR656 NTSC mode Time that CCIR_V to 1st line Tvs Th Control by HDLY[6:0] setting 12 20 28 data input Tvs = HDLY[6:0] @CCIR656 PAL mode Time that CCIR V to 1st line Tvs 17 25 33 Th Control by HDLY[6:0] setting data input Tvs = HDLY[6:0] @24bit RGB HV mode Time that VSD to 1st line 127 Th Control by HDLY[6:0] setting Tvs 2 13 data input Tvs = HDLY[6:0] 96% final, CL=30pF, RL=2K Source output stable time 1 Tst -25 30 us Gate output stable time 500 1000 96% final, CL=40pF Tgst . ns VCOMOUT output stable 96% final, CL=33nF, RL=100ohm Tcst 4 8 us time 3-wire serial communication AC timing Tspck Serial clock 320 -. ns SPCK pulse duty 40 50 60 % Tckh / Tspck Serial data setup time Tisu 120 -ns Serial data hold time Tihd 120 -ns Serial clock high/low Tckh/l 120 -ns Chip select distinguish Tcd 1 us -SPENB to VSD Tcv 1 -. us SPENB input setup time Teck 150 -ns SPENB input hold time Tcke 150 -. ns

Test Condition: (VDD=VDDP=3.3V, VDDA=5.0V, GND=GNDA=GNDP=0V, TA= 25℃)

6.2 DC Electrical Characteristics

Recommended Operating Range

ltem	Symbol	Min.	Тур.	Max.	Unit	Conditions
Supply Voltage	VDD	3.0	3.3	3.6	V	
IO Supply Voltage	VDDI	3.0	-	3.6	V	
Charge Pump Supply Voltage	PVDD	3.0	3.3	3.6	V	

DC Characteristics for Digital Circuit

ltem	Symbol	Min.	Тур.	Max.	Unit	Conditions
Logic-High Input Voltage	Vih	0.7VDDI	-	VDDI	V	
Logic-Low Input Voltage	Vil	DGND	-	0.3VDDI	٧	
Logic-High Output Voltage	Voh	VDDI-0.4	-	VDDI	V	
Logic-Low Output Voltage	Vol	DGND	-	DGND+0.4	٧	

DC Characteristics for Analog Circuit

ltem	Symbol	Min.	Тур.	Max.	Unit	Conditions
Positive High-Voltage Power	VGH	13	15	16.5	V	
Negative High-Voltage Power	VGL	-7	-10	-11	V	
Output Voltage Deviation	Vod	-	±35	±45	mV	No Load@
Standby Current	lsc	-		50	uA	FR=60Hz
Operation Current	loc	-	20		mA	

6.3 24 Bit RGB Mode

		Parallel 2	4-bit RC	GB Input	t Timing	Table	
	ltem	Symbol	Min.	Тур.	Max.	Unit	Note
DCLK	Frequency	Fclk	5	6	8	MHz	
DCI	LK Period	Tclk	125	167	200	ns	
	Period Time	Th	325	371	438	DCLK	
	Display Period	Thdisp		320		DCLK	
HSYNC	Back Porch	Thbp	3	43	43	DCLK	SYNC mode back porch control by H_BLANKING[7:0] setting Thbp= H_BLANKING[7:0]
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	43	DCLK	
	Period Time	Τv	244	260	289	HSYNC	
	Display Period	Tvdisp		240		HSYNC	
VSYNC	Back Porch	Tvbp	2	12	12	HSYNC	SYNC mode back porch control by V_BLANKING[7:0] setting Tvbp= V_BLANKING[7:0]
	Front Porch	Tvfp	2	8	37	HSYNC	
	Pulse Width	Tvw	2	4	12	HSYNC	

Parallel 24-bit RGB Input Timing (PVDD=VDD=VDDI= 3.3V, AGND= 0V, TA=25°C)

Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

6.4 Input Data Timing



6.5 Vertical Timing Diagram (HV Mode)





6.6 Vertical Timing Diagram (DE Mode)

7. Optical Characteristics

ltems)	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response time		Tr+Tf		-	50	80	ms	FIG.1	Note4
Contrast F	Ratio	CR	-	-	600	-	-	FIG.2	Note1
Surface Iuminan		LV	θ =0°	850	1000	-	cd/m2	FIG.2	Note2
Luminan uniform		Yu	θ =0°	75	80	-	%	FIG.2	Note3
NTSC	;	-	θ =0°	-	50	-	%	FIG.2	Note5
			∅ = 90°	-	80	-	deg	FIG.3	
Viewing e	nalo	θ	∅ =270°	-	80	-	deg	FIG.3	Note6
Viewing a	ngie	Cr>10	⊗=0°	-	80	-	deg	FIG.3	NOLEO
			∅=180°	-	80	-	deg	FIG.3	
	Red	Rx		0.596	0.646	0.696	-		
	Neu	Ry	θ =0°	0.282	0.332	0.382	-		
	Green	Gx	0 –0	0.273	0.323	0.373	-		
Chromaticity	Green	Gy	⊗=0°	0.517	0.567	0.617	-	FIG.2	Note5
Chilomaticity	Blue	Bx	Ta=25°	0.084	0.134	0.184	-	CIE1931	NULEU
	Diuc	By	10-25	0.071	0.121	0.171	-		
	White	Wx		0.282	0.332	0.382	-		
	VIIIC	WY		0.334	0.384	0.434	-		

Note1. Definition of contrast ratio

Contrast ratio=

Contrast ratio(Cr) is defined mathematically by the following formula. For more information see FIG.2.

Luminance with all pixels white

Luminance with all pixels black

For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is based on TOPCON' s BM-5 or BM-7 photo detector or compatible.

Note2. Definition of surface luminance.

Surface luminance is the luminance with all pixels displaying white. For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels (P1,P2,P3,,Pn)

Note3. Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through

n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

Note4. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (Tr) is the time between photo detector output intensity changed from 90% to 10%. And fall time (Tf) is the time between photo detector output intensity changed from 10% to 90%.

For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. Angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers' s ConoScope or DMS series Instruments or compatible.

FIG.1.The definition of response Time



FIG.2. Measuring method for contrast ratio, surface luminance,

luminance uniformity, CIE (x,y) chromaticity

Size: S \leq 5"(see Figure a) A : 5 mm B : 5 mm H,V: Active area Light spot size \oslash =5mm (BM-5) or \oslash =7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens. test spot position : see Figure a.

measurement instrument : TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c).



Size: 5" < S≤12.3"(see Figure b) H,V : Active area

Light spot size \oslash =5mm (BM-5) or \oslash =7.7mm (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens. test spot position : see Figure b.

measurement instrument: TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c).





FIG.3.The definition of viewing angle



8. Environmental / Reliability Tests

No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts= +70°C, 96hrs	Note 1 IEC60068-2-2, GB2423. 2-89
2	Low Temperature Operation	Ta= -20°C, 96hrs	Note 2 IEC60068-2-1 GB2423.1-89
3	High Temperature Storage	Ta= +80°C, 120hrs	IEC60068-2-2 GB2423. 2-89
4	Low Temperature Storage	Ta= -30°C, 120hrs	IEC60068-2-1 GB/T2423.1-89
5	High Temperature & Humidity Storage	Ta= +60°C, 90% RH max,120 hours	IEC60068-2-3 GB/T2423.3-2006
6	Thermal Shock (Non-operation)	-20°C 30 min ~ +60°C 30 min Change time: 5min, 30 Cycle	Start with cold temperature, end with high temperature IEC60068-2-14, GB2423.22-87
7	Electro Static Discharge (Operation)	C=150pF, R=330 Ω, 5 points/panel Air:±8KV, 5 times; Contact: ±4KV, 5 times; (Environment: 15°C ~ 35°C, 30% ~ 60%, 86Kpa ~ 106Kpa)	IEC61000-4-2 GB/T17626.2-1998
8	Vibration (Non-operation)	Frequency range: 10~55Hz, Stroke: 1.mm Sweep: 10Hz~55Hz~10Hz 2 hours for each direction of X .Y. Z. (package condition)	IEC60068-2-6 GB/T2423.5-1995
9	Shock (Non-operation)	60G 6ms, ± X, ±Y , ± Z 3 times for each direction	IEC60068-2-27 GB/T2423.5-1995
10	Package Drop Test	Height: 80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8-1995

Note: 1. Ts is the temperature of panel's surface.

- 2. Ta is the ambient temperature of sample.
- 3. The size of sample is 5pcs.

9. Mechanical Drawing



10. Packing

Packing Method







80 PCS

80*2 PCS





160 PCS





11. TFT-LCD Module Inspection Criteria

11.1 Scope

The incoming inspection standards shall be applied to TFT–LCD Modules (hereinafter called "Modules") that supplied by GlobalTech Display.

11.2 Incoming Inspection

The customer shall inspect the modules within twenty calendar days of the delivery date (the inspection period) at its own cost. The result of the inspection (acceptance or rejection) shall be recorded in writing, and a copy of this writing will be promptly sent to the seller, If the results of the inspecting from buyer does not send to the seller within twenty calendar days of the delivery date. The modules shall be regards as acceptance. Should the customer fail to notify the seller within the inspection period, the buyer's right to reject the modules shall be lapsed and the modules shall be deemed to have been accepted by the buyer.

11.3 Inspection Sampling

- 11.3.1. Lot size: Quantity per shipment lot per model
- 11.3.2. Sampling type: Normal inspection, Single sampling
- 11.3.3. Inspection level: II
- 11.3.4. Sampling table: MIL-STD-105E
- 11.3.5. Acceptable quality level (AQL). Major defect: AQL=0.65 Minor defect: AQL=1.00

11.4 Inspection Conditions

11.4.1 Ambient conditions:

- a. Temperature: Room temperature $25\pm5^\circ$ C
- b. Humidity: (60 ± 10) %RH
- c. Illumination: Single fluorescent lamp non-directive (300 to 700 Lux)
- 11.4.2 Viewing distance

The distance between the LCD and the inspector's eyes shall be at least 35 ± 5 cm.

11.4.3 Viewing Angle

U/D: 45° / 45° , L/R: 45° / 45°



11.5 Inspection Criteria

Defects are classified as major defects and minor defects according to the degree of Defectiveness defined herein.

11.5.1 Major defect

Item No	Items to be inspected	Inspection Standard
5.1.1	All functional defects	 No display Display abnormally Short circuit line defect
`5.1.2	Missing	Missing function component
5.1.3	Crack	Glass Crack

11.5.2 Minor defect

Item No	Items to be inspected	Inspection standard	
5.2.1	Spot Defect Including Black spot White spot	For dark/white spot is defined $\varphi = (\mathbf{x} + \mathbf{y}) / 2$ $\longrightarrow \mathbf{x} \qquad \qquad$	
	Pinhole Foreign particle	Size $\phi(mm)$	Acceptable Quantity
	Polarizer dirt	φ ≤0.05	Ignore
		0.05 < ¢ ≤0.15	2
		0.15< ¢	Not allowed
5.2.2	Polarizer dirt, particle	Size ϕ (mm)	Acceptable Quantity
		φ ≤0.15	1
		Φ>0.15	Not allowed
		Define:	
5.2.3	Line Defect		
	Including Black line		
	White line Scratch		







- Note: 1). Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.
 - 2). The distance between two bright dot defects (red, green, blue, and white) should be larger than 15mm.
 - 3). The distance between black dot defects or black and bright dot defects should be more than 5mm apart.
 - 4). Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.

11.6 Mechanics specification

As for the outside dimension, weight of the modules, please refer to product specification For more details

12. Precautions for Use of LCD modules

12.1 Handling Precautions

12.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.

12.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.

12.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

12.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

12.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketene
- Aromatic solvents
- 12.1.6. Do not attempt to disassemble the LCD Module.
- 12.1.7. If the logic circuit power is off, do not apply the input signals.
- 12.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 12.1.8.1. Be sure to ground the body when handling the LCD Modules.
- 12.1.8.2. Tools required for assembly, such as soldering irons, must be properly ground.
- 12.1.8.3. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

12.1.8.4. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

12.2 Storage Precautions

12.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

12.2.2. The LCD modules should be stored under the storage temperature range If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: 0°C ~ 40°C

Relatively humidity: ≤80%

12.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.

12.3 Transportation Precautions

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.